



AiP74LVC574

Octal D-type flip-flop; positive edge-trigger; 3-state

Product Specification

Specification Revision History:

Version	Date	Description
2019-05-A0	2019-05	New
2023-10-A1	2023-10	Parameter modification



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1、 General Description

The AiP74LVC574 is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications.

The input can be driven from either 3.3V or 5V devices. This feature allows the use of this device in a mixed 3.3V and 5V environment.

Features:

- Supply voltage range:1.2V to 3.6V
- Inputs accept voltages up to 5.5V
- $\pm 24\text{mA}$ output drive at 3.0V
- High-impedance when $V_{CC}=0\text{V}$
- Temperature range:-40°C to +125°C
- Packaging information: SOP20/TSSOP20/DHVQFN20

Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
AiP74LVC574SA20.TB	SOP20	74LVC574	35 PCS/tube	80 tube/box	2800 PCS/box	Dimensions of plastic enclosure: 12.8mm×7.5mm Pin spacing: 1.27mm
AiP74LVC574TA20.TB	TSSOP20	74LVC574	70 PCS/tube	200 tube/box	14000 PCS/box	Dimensions of plastic enclosure: 6.5mm×4.4mm Pin spacing: 0.65mm

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
AiP74LVC574SA20.TR	SOP20	74LVC574	2000 PCS/reel	2000 PCS/box	Dimensions of plastic enclosure: 12.8mm×7.5mm Pin spacing:1.27mm
AiP74LVC574TA20.TR	TSSOP20	74LVC574	4000 PCS/reel	8000 PCS/box	Dimensions of plastic enclosure: 6.5mm×4.4mm Pin spacing:0.65mm



Wuxi I-CORE Electronics Co., Ltd.

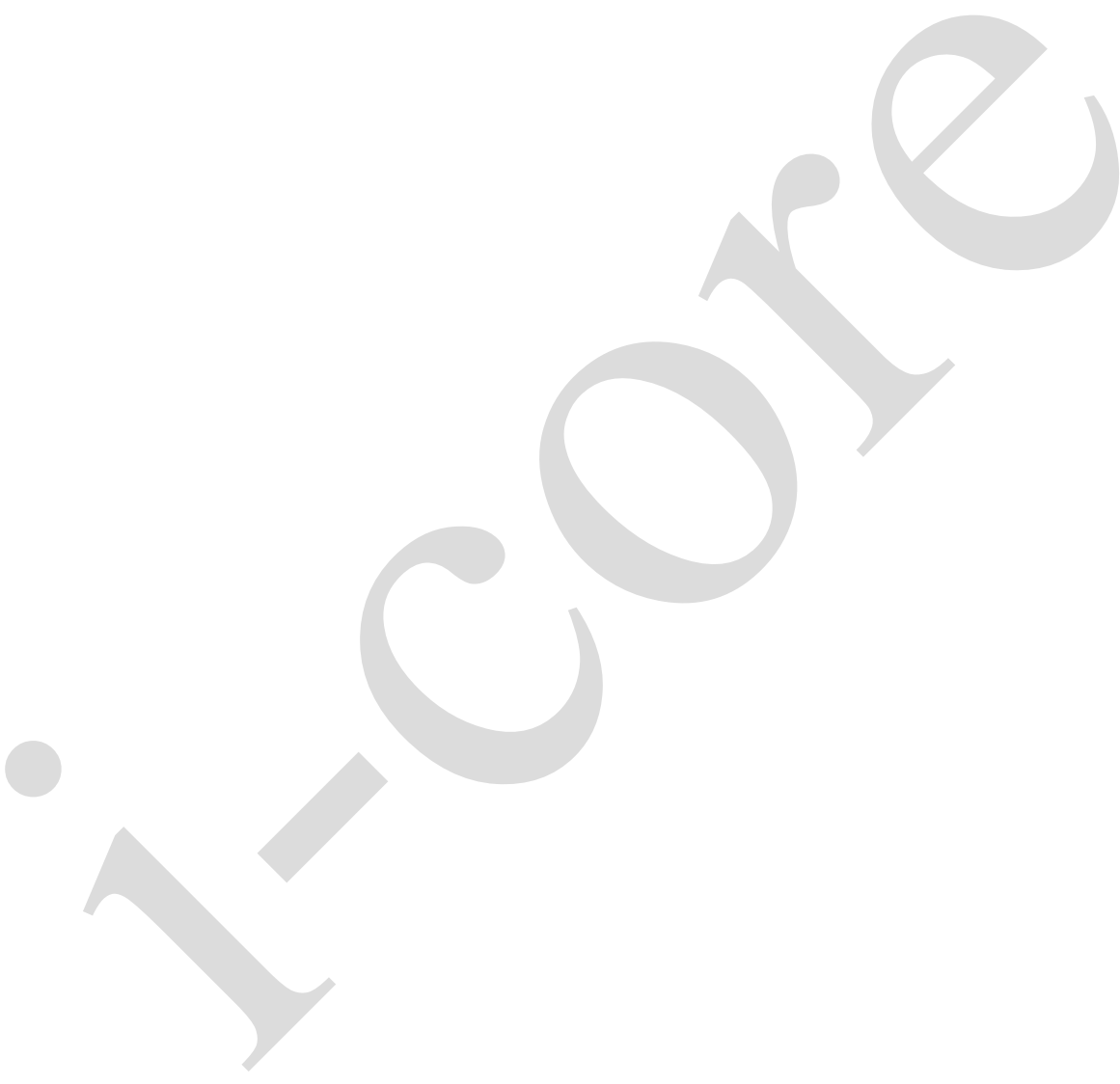
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Number: AiP74LVC574-AX-LJ-B103EN

AiP74LVC574QE20.TR	DHVQFN20	74LVC574	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 4.5mm×2.5mm Pin spacing:0.5mm
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Note 1: "XX" refers to variable content, meaning year and package batch serial number.

Note 2: If the physical information is inconsistent with the ordering information, please refer to the actual product.





2、Block Diagram And Pin Description

2.1、Block Diagram

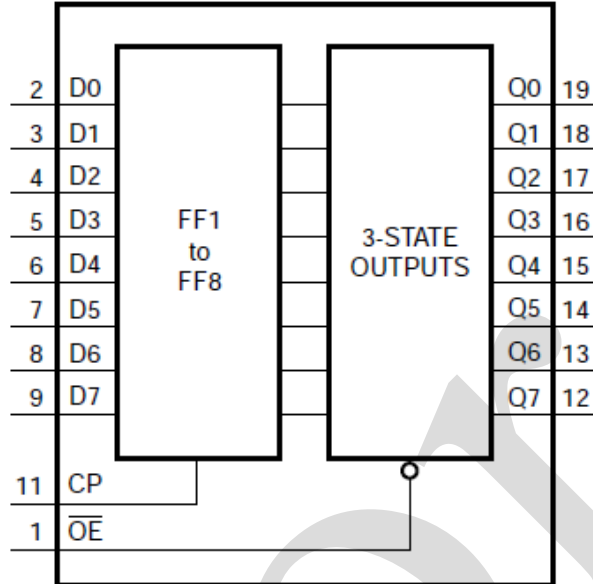


Figure 1. Functional diagram

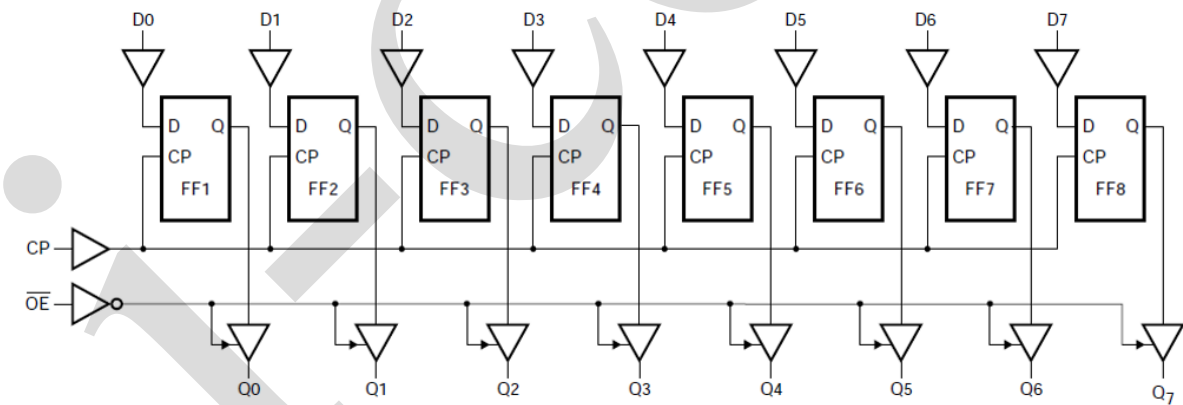
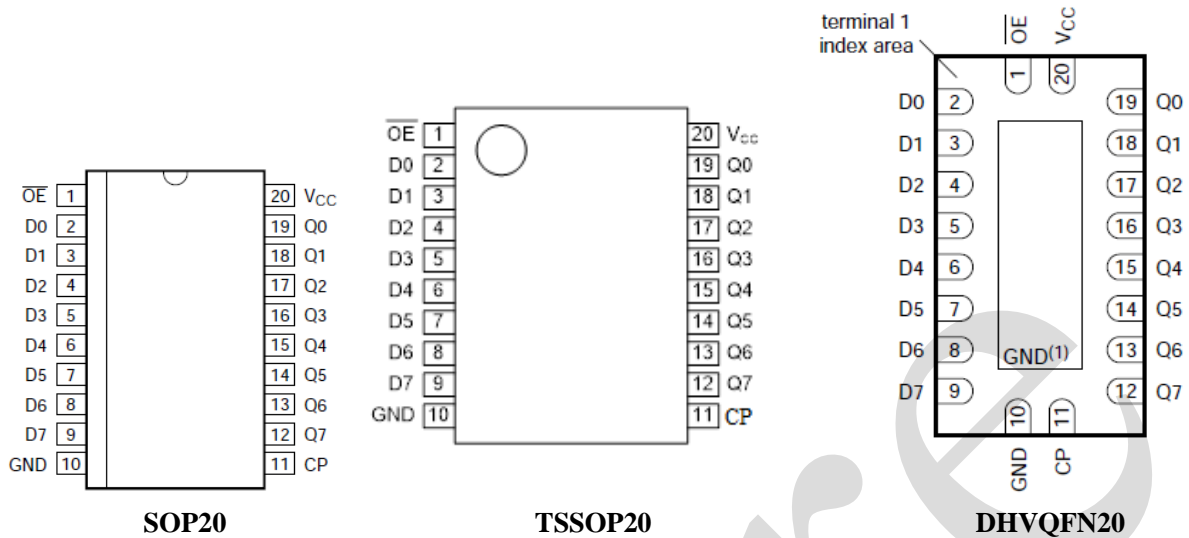


Figure 2. Logic diagram



2.2、Pin Configurations



Note: (1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.

2.3、Pin Description

Pin No.	Pin Name	Description
1	OE	output enable input (active LOW)
2	D0	data input
3	D1	data input
4	D2	data input
5	D3	data input
6	D4	data input
7	D5	data input
8	D6	data input
9	D7	data input
10	GND	ground (0V)
11	CP	clock input (LOW to HIGH; edge triggered)
12	Q7	data output
13	Q6	data output
14	Q5	data output
15	Q4	data output
16	Q3	data output
17	Q2	data output
18	Q1	data output
19	Q0	data output
20	V _{CC}	supply voltage



2.4、Function Table

Operating modes	Input			Internal flip-flop	Output
	OE	CP	Dn		Qn
Load and read register	L	↑	l	L	L
	L	↑	h	H	H
Load register and disable outputs	H	↑	l	L	Z
	H	↑	h	H	Z

Note:

H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition

L = LOW voltage level;

l = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition

↑ = LOW to HIGH clock transition

Z = high-impedance OFF-state

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(T_{amb}=25°C, All voltage referenced to V_{ss}, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V _{CC}	-	-0.5	+6.5	V
input voltage	V _I	-	-0.5	+6.5	V
output voltage	V _O	Active mode	-0.5	V _{CC} +0.5	V
		Power-down mode; V _{CC} =0V	-0.5	+6.5	V
		output 3-state	-0.5	+6.5	V
supply current	I _{CC}	-	-	100	mA
ground current	I _{GND}	-	-100	-	mA
input clamping current	I _{IK}	V _I < 0V	-50	-	mA
output current	I _O	V _O =0V to V _{CC}	-	±50	mA
output clamping current	I _{OK}	V _O > V _{CC} or V _O < 0V	-	±50	mA
storage temperature	T _{stg}	-	-65	+150	°C
Soldering temperature	T _L	10s	260		°C

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V _{CC}	-	1.2	-	3.6	V
input voltage	V _I	-	0	-	5.5	V
output voltage	V _O	Active mode	0	-	V _{CC}	V
		Power-down mode; V _{CC} =0V	0	-	5.5	V
		output 3-state	0	-	5.5	V
ambient temperature	T _{amb}	-	-40	-	+125	°C



3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V _{IH}	1.2V	-	1.08	-	-	V
		1.65V to 1.95V	-	0.65 × V _{CC}	-	-	V
		2.3V to 2.7V	-	1.7	-	-	V
		2.7V to 3.6V	-	2.0	-	-	V
LOW-level input voltage	V _{IL}	1.2V	-	-	-	0.12	V
		1.65V to 1.95V	-	-	-	0.35 ×	V
		2.3V to 2.7V	-	-	-	0.7	V
		2.7V to 3.6V	-	-	-	0.8	V
HIGH-level output voltage	V _{OH}	1.65V to 3.6V	I _O = -100uA	V _{CC} - 0.2	-	-	V
		1.65V	I _O = -4mA	1.2	-	-	V
		2.3V	I _O = -8mA	1.8	-	-	V
		2.7V	I _O = -12mA	2.2	-	-	V
		3.0V	I _O = -18mA	2.4	-	-	V
		3.0V	I _O = -24mA	2.2	-	-	V
LOW-level output voltage	V _{OL}	1.65V to 3.6V	I _O = 100uA	-	-	0.2	V
		1.65V	I _O = 4mA	-	-	0.45	V
		2.3V	I _O = 8mA	-	-	0.6	V
		2.7V	I _O = 12mA	-	-	0.4	V
		3.0V	I _O = 24mA	-	-	0.55	V
input leakage	I _I	3.6V	V _I = 5.5V or GND	-	-	±5	uA
OFF-state output current	I _{OZ}	3.6V	V _I = V _{IH} or V _{IL} ; V _O = 5.5V or GND	-	-	±5	uA
power-off leakage current	I _{OFF}	0V	V _I or V _O = 5.5V	-	-	±10	uA
supply current	I _{CC}	3.6V	V _I = V _{CC} or GND; I _O = 0A	-	-	10	uA
additional supply current	ΔI _{CC}	2.7V to 3.6V	per input pin; V _I = V _{CC} - 0.6V;	-	-	500	uA



3.3.2、DC Characteristics 2

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V _{IH}	1.2V	-	1.08	-	-	V
		1.65V to 1.95V	-	0.65× V _{CC}	-	-	V
		2.3V to 2.7V	-	1.7	-	-	V
		2.7V to 3.6V	-	2.0	-	-	V
LOW-level input voltage	V _{IL}	1.2V	-	-	-	0.12	V
		1.65V to 1.95V	-	-	-	0.35×	V
		2.3V to 2.7V	-	-	-	0.7	V
		2.7V to 3.6V	-	-	-	0.8	V
HIGH-level output voltage	V _{OH}	1.65V to 3.6V	I _O =-100uA	V _{CC} - 0.3	-	-	V
		1.65V	I _O =-4mA	1.05	-	-	V
		2.3V	I _O =-8mA	1.65	-	-	V
		2.7V	I _O =-12mA	2.05	-	-	V
		3.0V	I _O =-18mA	2.25	-	-	V
		3.0V	I _O =-24mA	2.0	-	-	V
LOW-level output voltage	V _{OL}	1.65V to 3.6V	I _O =100uA	-	-	0.3	V
		1.65V	I _O =4mA	-	-	0.65	V
		2.3V	I _O =8mA	-	-	0.8	V
		2.7V	I _O =12mA	-	-	0.6	V
		3.0V	I _O =24mA	-	-	0.8	V
input leakage	I _I	3.6V	V _I =5.5V or GND	-	-	±20	uA
OFF-state output current	I _{OZ}	3.6V	V _I =V _{IH} or V _{IL} ; V _O =5.5V or GND	-	-	±20	uA
power-off leakage current	I _{OFF}	0V	V _I or V _O =5.5V	-	-	±20	uA
supply current	I _{CC}	3.6V	V _I =V _{CC} or GND; I _O =0A	-	-	40	uA
additional supply current	ΔI _{CC}	2.7V to 3.6V	per input pin; V _I = V _{CC} -0.6V;	-	-	5000	uA



3.3.3、AC Characteristics 1

($T_{amb}=-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ. ^[1]	Max.	Unit
CP to Qn propagation delay	t _{PLH} , t _{PHL}	1.2V	see Figure 4	-	17.0	-	ns
		1.65V to 1.95V		4.6	6.4	13.1	ns
		2.3V to 2.7V		2.6	3.9	7.9	ns
		2.7V		1.5	3.7	8.0	ns
		3.0V to 3.6V		1.5	3.5	7.0	ns
OE to Qn; enable time	t _{PZH} , t _{PZL}	1.2V	see Figure 5	-	19.0	-	ns
		1.65V to 1.95V		1.5	7.0	17.1	ns
		2.3V to 2.7V		1.5	4.0	9.4	ns
		2.7V		1.5	4.1	8.5	ns
		3.0V to 3.6V		1.5	3.2	7.5	ns
OE to Qn disable time	t _{PLZ} , t _{PHZ}	1.2V	see Figure 5	-	9.0	-	ns
		1.65V to 1.95V		2.5	4.1	10.1	ns
		2.3V to 2.7V		1.0	2.3	5.7	ns
		2.7V		1.5	3.1	6.5	ns
		3.0V to 3.6V		1.5	2.9	6.0	ns
CP HIGH or LOW pulse width	t _w	1.65V to 1.95V	see Figure 4	5.0	-	-	ns
		2.3V to 2.7V		4.0	-	-	ns
		2.7V		3.3	-	-	ns
		3.0V to 3.6V		3.3	1.7	-	ns
Dn to CP set-up time	t _{su}	1.65V to 1.95V	see Figure 6	4.0	-	-	ns
		2.3V to 2.7V		2.5	-	-	ns
		2.7V		2.0	-	-	ns
		3.0V to 3.6V		2.0	0.3	-	ns
Dn to CP hold time	t _h	1.65V to 1.95V	see Figure 4	3.0	-	-	ns
		2.3V to 2.7V		2.0	-	-	ns
		2.7V		1.5	-	-	ns
		3.0V to 3.6V		+1.5	-0.2	-	ns
maximum frequency	f _{max}	1.65V to 1.95V	see Figure 6	100	-	-	MHz
		2.3V to 2.7V		125	-	-	MHz
		2.7V		150	-	-	MHz
		3.0V to 3.6V		150	-	-	MHz

Note:

[1] Typical values are measured at $T_{amb}=25^{\circ}\text{C}$ and $V_{CC}=1.2\text{V}$, 1.8V , 2.5V , 2.7V , and 3.3V respectively.



3.3.4、AC Characteristics 2

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit
CP to Qn propagation delay	t _{PLH} , t _{PHL}	1.65V to 1.95V	see Figure 4	4.6	-	15.1	ns
		2.3V to 2.7V		2.6	-	9.1	ns
		2.7V		1.5	-	10.0	ns
		3.0V to 3.6V		1.5	-	9.0	ns
OE to Qn; enable time	t _{PLZ} , t _{PHZ}	1.65V to 1.95V	see Figure 5	1.5	-	19.8	ns
		2.3V to 2.7V		1.5	-	10.9	ns
		2.7V		1.5	-	11.0	ns
		3.0V to 3.6V		1.5	-	9.5	ns
OE to Qn disable time	t _{PLZ} , t _{PHZ}	1.65V to 1.95V	see Figure 5	2.5	-	11.6	ns
		2.3V to 2.7V		1.0	-	6.6	ns
		2.7V		1.5	-	8.5	ns
		3.0V to 3.6V		1.5	-	7.5	ns
CP HIGH or LOW pulse width	t _w	1.65V to 1.95V	see Figure 4	5.0	-	-	ns
		2.3V to 2.7V		4.0	-	-	ns
		2.7V		3.3	-	-	ns
		3.0V to 3.6V		3.3	-	-	ns
Dn to CP set-up time	t _{su}	1.65V to 1.95V	see Figure 6	4.0	-	-	ns
		2.3V to 2.7V		2.5	-	-	ns
		2.7V		2.0	-	-	ns
		3.0V to 3.6V		2.0	-	-	ns
Dn to CP hold time	t _h	1.65V to 1.95V	see Figure 6	3.0	-	-	ns
		2.3V to 2.7V		2.0	-	-	ns
		2.7V		1.5	-	-	ns
		3.0V to 3.6V		+1.5	-	-	ns
maximum frequency	f _{max}	1.65V to 1.95V	see Figure 4	80	-	-	MHz
		2.3V to 2.7V		100	-	-	MHz
		2.7V		120	-	-	MHz
		3.0V to 3.6V		120	-	-	MHz



4、Testing Circuit

4.1、AC Testing Circuit

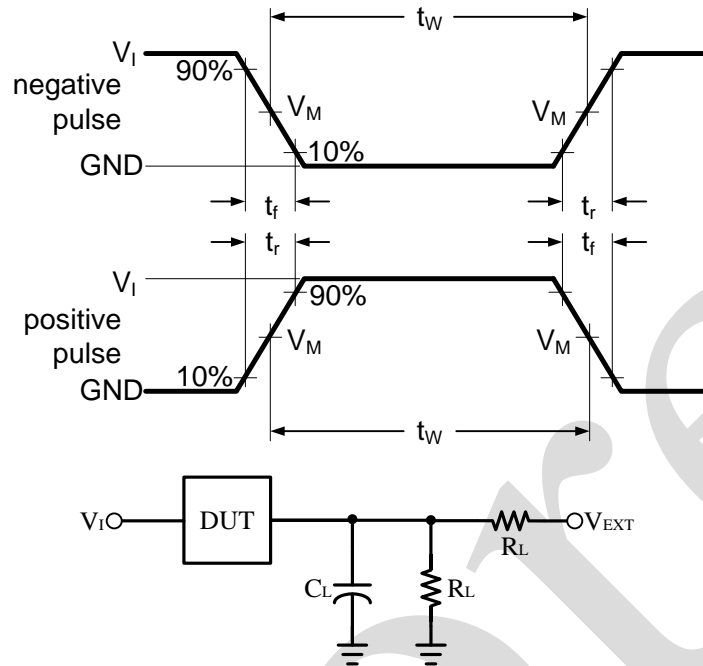


Figure 3. Test circuit for measuring switching times

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

4.2、Test Data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	t_r, t_f	C_L	R_L	t_{PLH}, t_{PHL}	t_{PLZ}, t_{PZL}	t_{PHZ}, t_{PZH}
1.2V	V_{CC}	$\leq 3ns$	30pF	1k Ω	open	$2 \times V_{CC}$	GND
1.65V to 1.95V	V_{CC}	$\leq 3ns$	30pF	1k Ω	open	$2 \times V_{CC}$	GND
2.3V to 2.7V	V_{CC}	$\leq 3ns$	30pF	500 Ω	open	$2 \times V_{CC}$	GND
2.7V	V_{CC}	$\leq 3ns$	50pF	500 Ω	open	$2 \times V_{CC}$	GND
3.0V to 3.6V	V_{CC}	$\leq 3ns$	50pF	500 Ω	open	$2 \times V_{CC}$	GND



4.3、AC Testing Waveforms

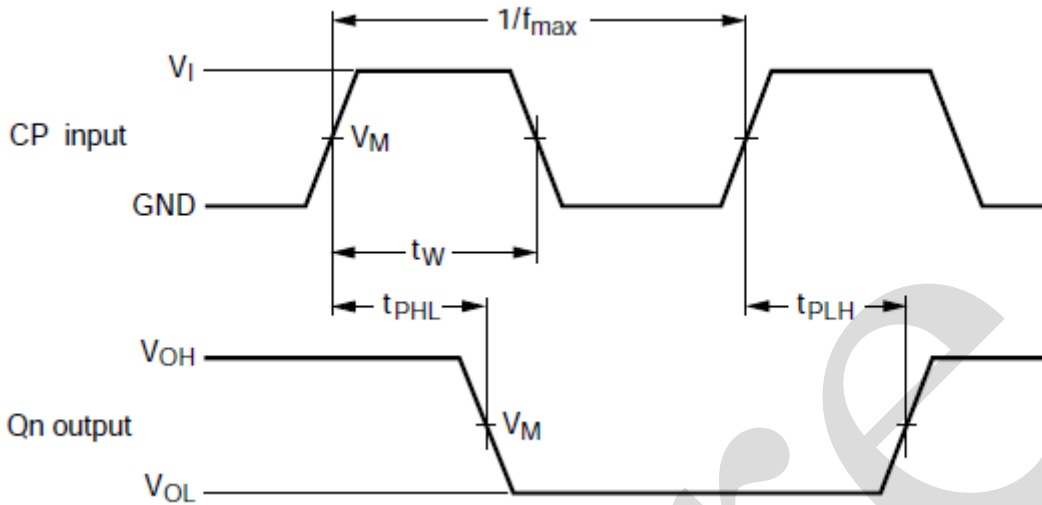


Figure 4. Clock (CP) to output (Qn) propagation delays, the clock pulse width, output transition times, and the maximum frequency

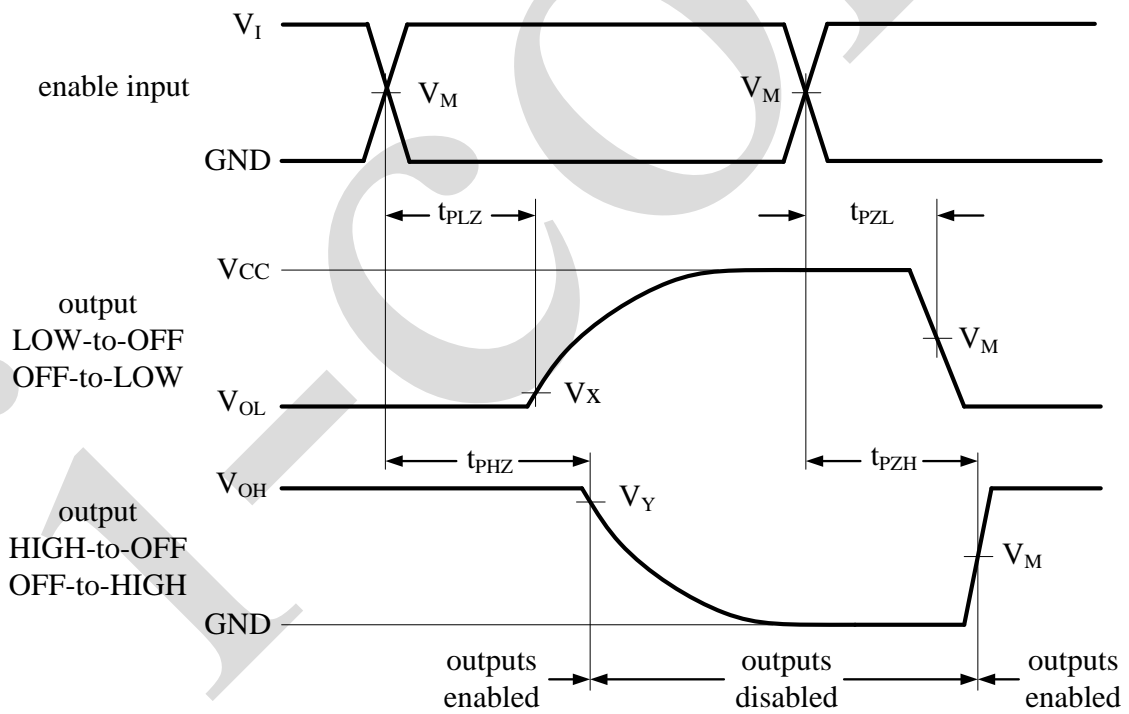


Figure 5. 3-state enable and disable times

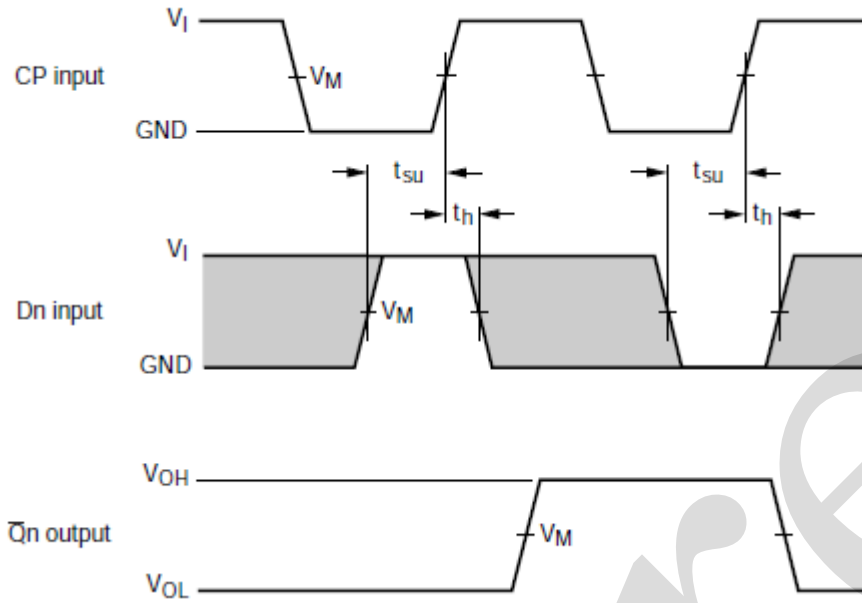


Figure 6. Data set-up and hold times for the Dn input to the CP input

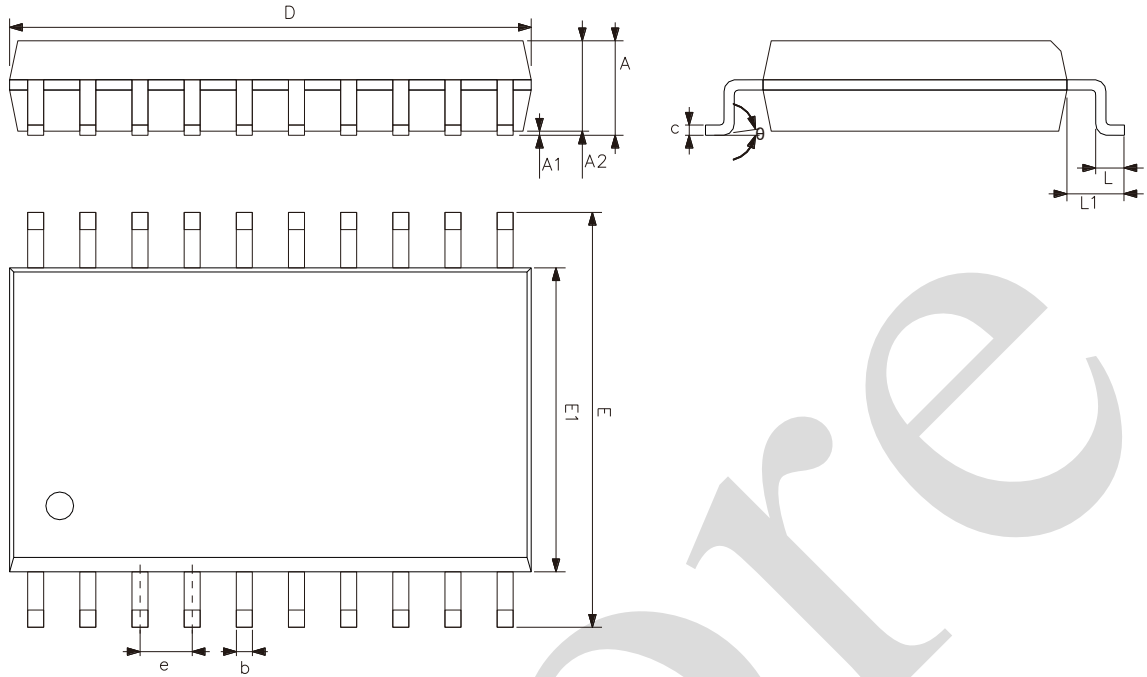
4.4、 Measurement Points

Supply voltage	Input	Output		
		V_M	V_X	V_Y
V_{CC}	V_M	V_M	V_X	V_Y
1.2V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
1.65V to 1.95V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
2.3V to 2.7V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
2.7V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.3V$	$V_{OH} - 0.3V$
3.0V to 3.6V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.3V$	$V_{OH} - 0.3V$



5、Package Information

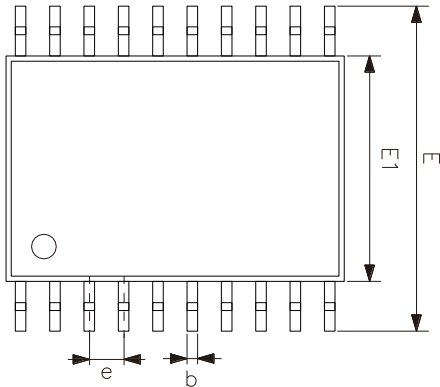
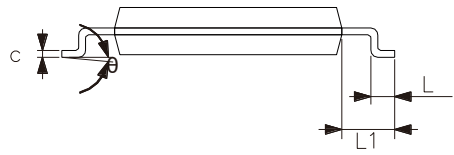
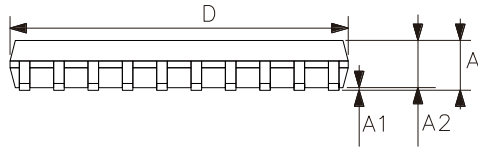
5.1、SOP20



Symbol	Dimensions (mm)	
	Min.	Max.
A	2.47	2.65
A1	0.05	0.30
A2	2.20	2.44
b	0.35	0.50
c	0.15	0.30
D	12.54	12.94
E	10.00	10.60
E1	7.30	7.70
e	1.27	
L	0.40	1.05
L1	1.30	1.50
θ	0°	8°



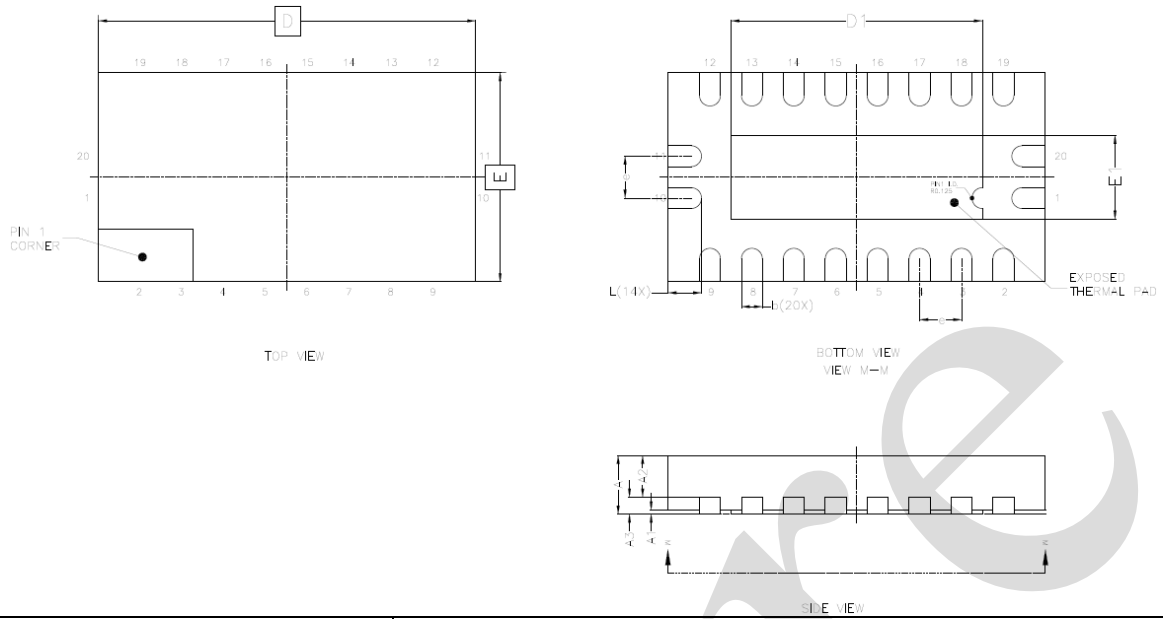
5.2、TSSOP20



Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	6.40	6.60
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
L1	1.00	
θ	0°	8°



5.3、DHVQFN20



Symbol	Dimensions (mm)	
	Min.	Max.
A	0.80	1.00
A1	0.00	0.05
A2	0.60	0.70
A3	0.20	
D	4.40	4.60
E	2.40	2.60
e	0.50	
b	0.18	0.30
L	0.30	0.50
D1	2.70	3.15
E1	0.70	1.15



6、 Statements And Notes

6.1、 The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、 Notes

We recommend you to read this chapter carefully before using this product.

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